

# TLP3130

MEASUREMENT INSTRUMENTS

LOGIC IC TESTERS / MEMORY TESTERS

BOARD TESTERS / SCANNERS

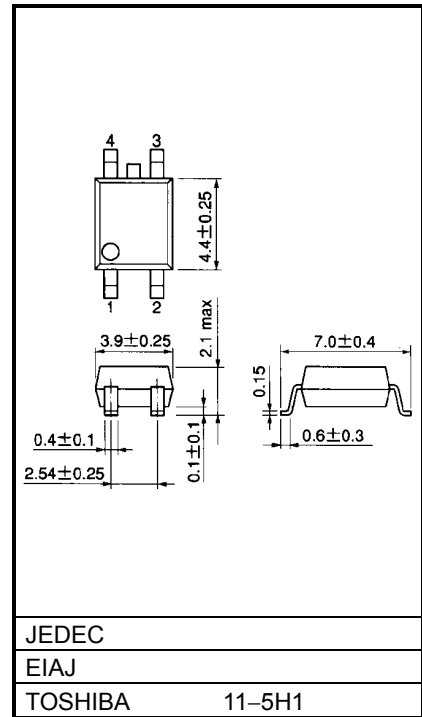
The TOSHIBA TLP3130 Mini-flat photorelay is a small-outline photorelay, suitable for surface-mount assembly. The TLP3130 consists of a GaAs infrared-emitting diode optically coupled to a photo-MOS FET and housed in a 4-pin package.

Its characteristics also include low OFF-state current and low output pin capacitance, enabling it to be used in high-frequency measuring instruments.

**FEATURES**

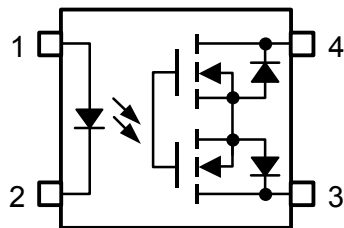
- 4 pin SOP (2.54SOP4) : 2.1 mm high, 2.54 mm pitch
- 1-Form-A
- Peak Off-State Voltage : 20 V (MIN.)
- Trigger LED Current : 4 mA (MAX.)
- On-State Current : 160 mA (MAX.)
- On-State Resistance : 8 Ω (MAX.), 5 Ω (TYP.)
- Output Capacitance : 2.5 pF (MAX.), 1.0 pF (TYP.)
- Isolation Voltage : 1500 V<sub>rms</sub> (MIN.)

Unit: mm



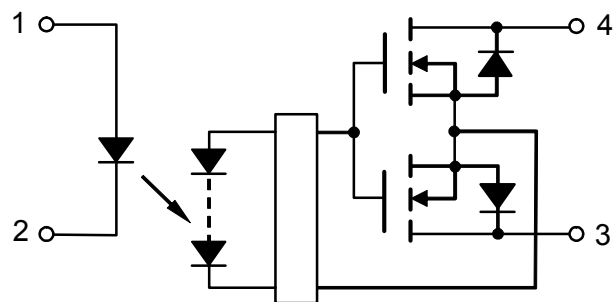
Weight: 0.1 g

**PIN CONFIGURATION (TOP VIEW)**



- 1 : ANODE
- 2 : CATHODE
- 3 : DRAIN
- 4 : DRAIN

**SCHEMATIC**



**MAXIMUM RATINGS (Ta = 25°C)**

CHARACTERISTIC		SYMBOL	RATING	UNIT
LED	Forward Current	I <sub>F</sub>	50	mA
	Forward Current Derating (Ta ≥ 25°C)	ΔI <sub>F</sub> /°C	-0.5	mA/°C
	Reverse Voltage	V <sub>R</sub>	5	V
	Junction Temperature	T <sub>j</sub>	125	°C
DETECTOR	Off-State Output Terminal Voltage	V <sub>OFF</sub>	20	V
	On-State Current	I <sub>ON</sub>	160	mA
	On-State Current Derating (Ta ≥ 25°C)	ΔI <sub>ON</sub> /°C	-1.6	mA/°C
	Junction Temperature	T <sub>j</sub>	125	°C
Storage Temperature Range		T <sub>stg</sub>	-40~125	°C
Operating Temperature Range		T <sub>opr</sub>	-20~85	°C
Lead Soldering Temperature (10 s)		T <sub>sol</sub>	260	°C
Isolation Voltage (AC, 1 minute, R.H. ≤ 60%) (NOTE1)		BV <sub>S</sub>	1500	Vrms

(NOTE1) : Device considered a two-terminal device : Pins 1 and, 2 shorted together, and pins 3 and 4 shorted together.

**CAUTION**

This device is sensitive to electrostatic discharge. When using this device, please ensure that all tools and equipment are earthed.

**RECOMMENDED OPERATING CONDITIONS**

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply Voltage	V <sub>DD</sub>	—	—	20	V
Forward Current	I <sub>F</sub>	10	—	30	mA
On-State Current	I <sub>ON</sub>	—	—	160	mA
Operating Temperature	T <sub>opr</sub>	25	—	60	°C

**INDIVIDUAL ELECTRICAL CHARACTERISTICS (Ta = 25°C)**

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
LED	Forward Voltage	V <sub>F</sub>	I <sub>F</sub> = 10 mA	1.0	1.15	1.3	V
	Reverse Current	I <sub>R</sub>	V <sub>R</sub> = 5 V	—	—	10	μA
	Capacitance	C <sub>T</sub>	V = 0, f = 1 MHz	—	15	—	pF
DETECTOR	Off-State Current	I <sub>OFF</sub>	V <sub>OFF</sub> = 20 V, Ta = 50°C	—	—	1000	pA
	Capacitance	C <sub>OFF</sub>	V = 0, f = 100 MHz, t < 1 s	—	1.0	2.5	pF

**COUPLED ELECTRICAL CHARACTERISTICS (Ta = 25°C)**

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Trigger LED Current	$I_{FT}$	$I_{ON} = 100 \text{ mA}$	—	—	4	mA
Return LED Current	$I_{FC}$	$I_{OFF} = 10 \text{ } \mu\text{A}$	0.2	0.75	—	mA
On-State Resistance	$R_{ON}$	$I_{ON} = 100 \text{ mA}, I_F = 5 \text{ mA}, t < 1 \text{ s}$	—	5	8	$\Omega$

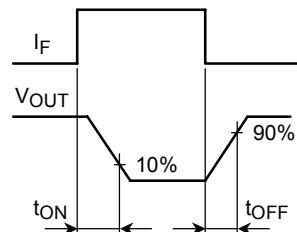
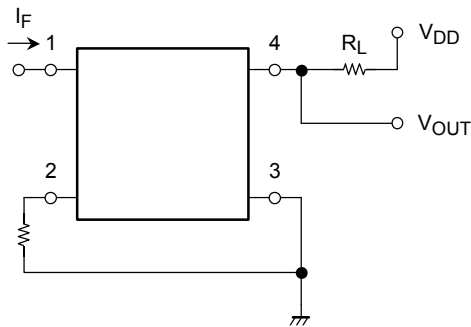
**ISOLATION CHARACTERISTICS (Ta = 25°C)**

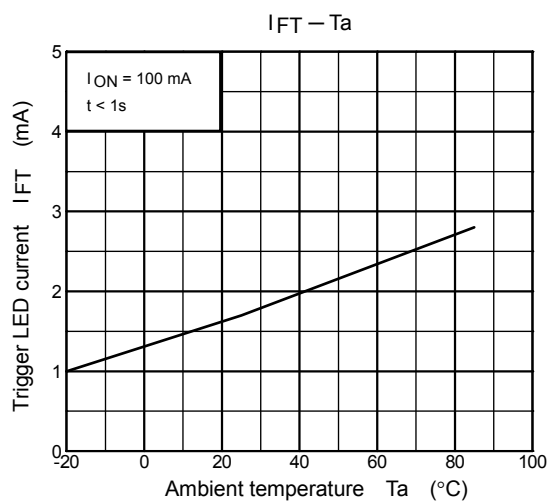
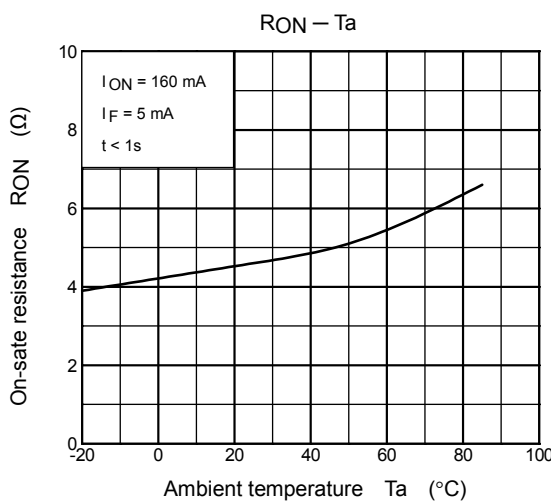
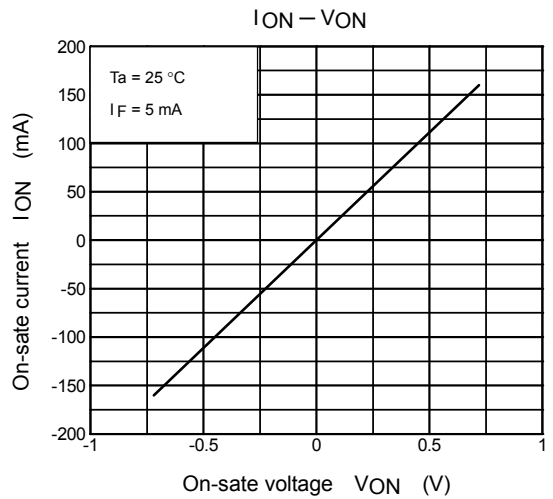
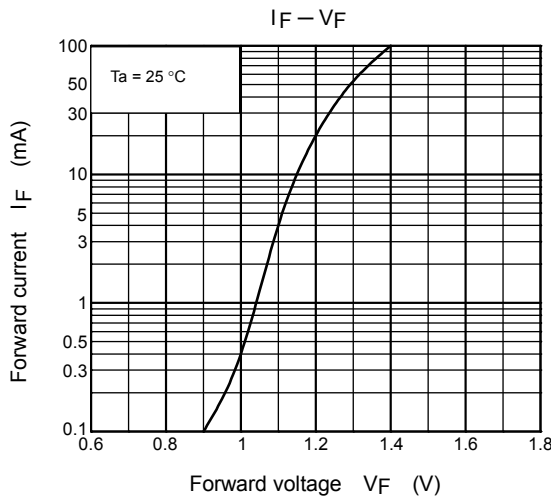
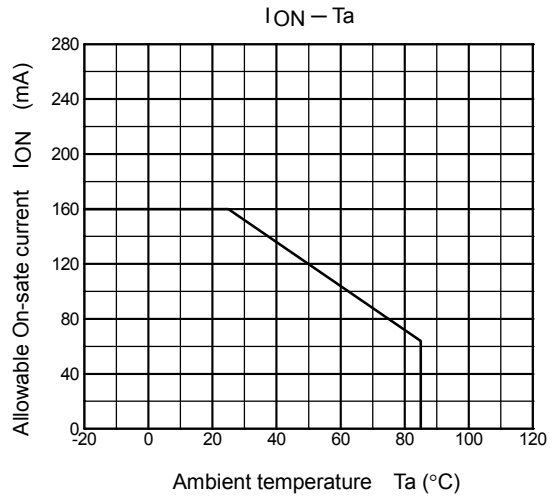
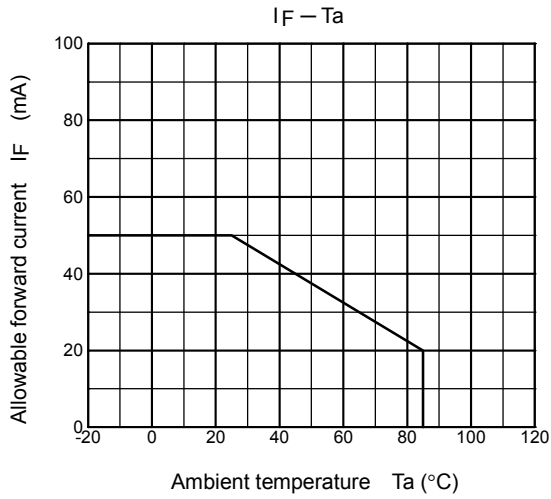
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Capacitance Input to Output	$C_S$	$V_S = 0 \text{ V}, f = 1 \text{ MHz}$	—	0.8	—	pF
Isolation Resistance	$R_S$	$V_S = 500 \text{ V}, \text{R.H.} \leq 60\%$	$5 \times 10^{10}$	$10^{14}$	—	$\Omega$
Isolation Voltage	$BV_S$	AC, 1 minute	1500	—	—	Vrms
		AC, 1 second (in oil)	—	3000	—	Vrms
		DC, 1 minute (in oil)	—	3000	—	Vdc

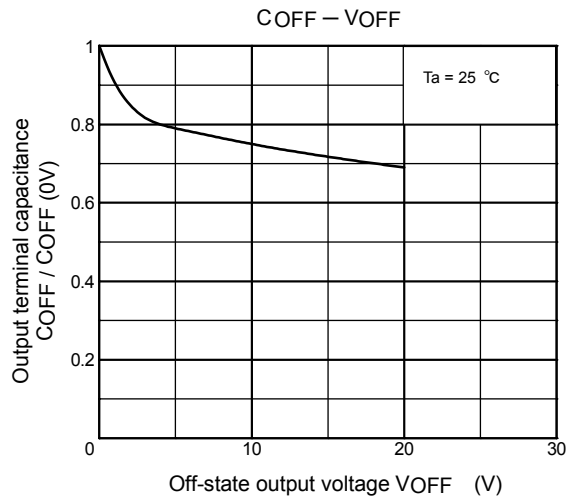
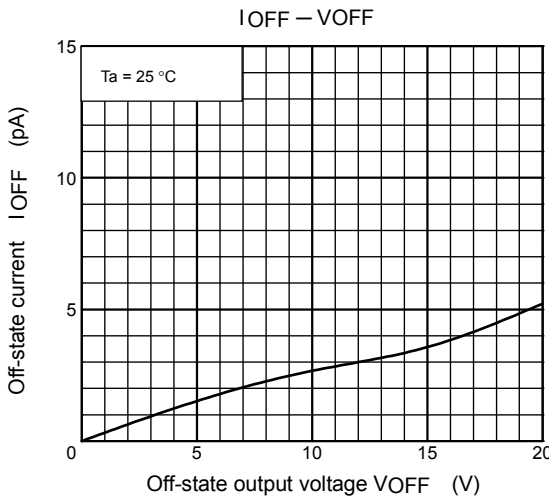
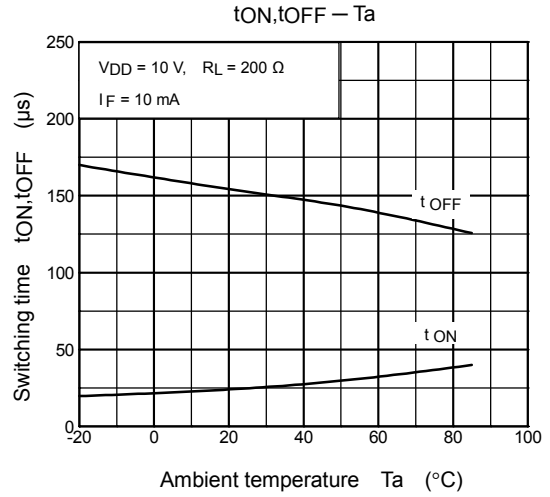
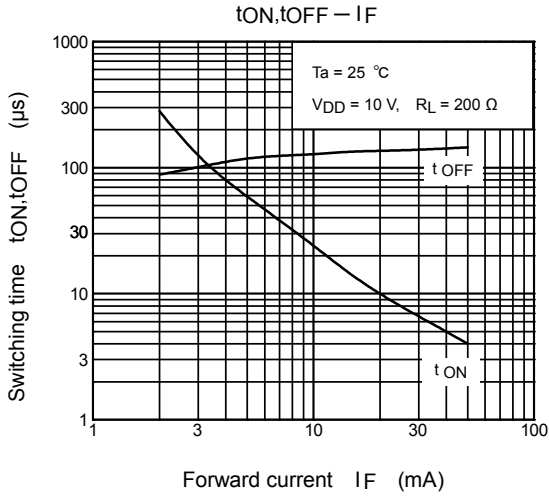
**SWITCHING CHARACTERISTICS (Ta = 25°C)**

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Turn-on Time	$t_{ON}$	$R_L = 200 \text{ } \Omega$ (NOTE 2) $V_{DD} = 10 \text{ V}, I_F = 10 \text{ mA}$	—	—	500	$\mu\text{s}$
Turn-off Time	$t_{OFF}$		—	—	500	

(NOTE 2) : SWITCHING TIME TEST CIRCUIT







**RESTRICTIONS ON PRODUCT USE**

020704EBC

- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property.  
In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc..
- The TOSHIBA products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.). These TOSHIBA products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury ("Unintended Usage"). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc.. Unintended Usage of TOSHIBA products listed in this document shall be made at the customer's own risk.
- Gallium (GaAs) Arsenide is a substance used in the products described in this document. GaAs dust or vapor is harmful to the human body. Do not break, cut, crush or dissolve chemically.
- The products described in this document are subject to the foreign exchange and foreign trade laws.
- The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by TOSHIBA CORPORATION for any infringements of intellectual property or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any intellectual property or other rights of TOSHIBA CORPORATION or others.
- The information contained herein is subject to change without notice.